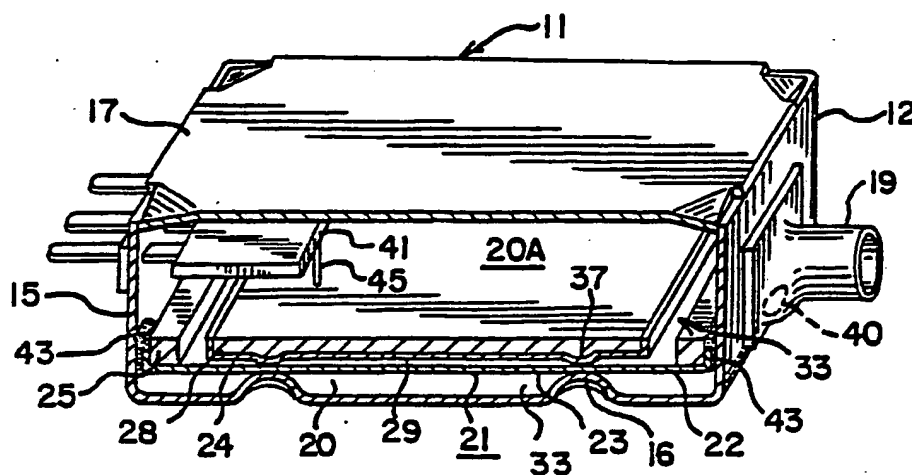




## INTERNATIONAL APPLICATION PUBLISHED UNDER THE PATENT COOPERATION TREATY (PCT)

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(54) Title: ACOUSTIC TRANSDUCER WITH IMPROVED ELECTRODE SPACING



## (57) Abstract

An acoustic transducer with an electret assembly mounting (21) for providing spacing (32) between a fixed electrode comprising a backplate (28), affixed to a support ring (25), and a movable electrode comprising a diaphragm (22), wherein the spacing (32) reduces the capacitance between peripheral stationary portions of the diaphragm (22) and the backplate (28).

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**ACOUSTIC TRANSDUCER WITH  
IMPROVED ELECTRODE SPACING**

**DESCRIPTION**

**Background of the Invention**

5                   The present invention is related to U.S.  
Patent No. 4,063,050 entitled "Acoustic Transducer  
with Improved Electret Assembly" issued to E. V.  
Carlson and M. C. Killion and assigned to the same  
assignee as the present invention. The disclosure of  
10 said patent is incorporated herein by reference.

                  The invention relates to an acoustic  
transducer of the type comprising an electret  
assembly including a diaphragm positioned adjacent a

backplate having an electret film formed thereon. The electret assembly is mounted within a case to form acoustic chambers on opposite sides of the diaphragm. The case includes a channel for  
5 permitting the external acoustic signal to enter into one of the acoustic chambers to enable the diaphragm to respond thereto. Openings are provided to permit the air pulsations created by the vibrations of the diaphragm to pass from one to the other acoustic  
10 chamber.

The electret comprises a dielectric film deposited on a backplate. The backplate includes protrusions which rest on support posts formed in the case to selectively space the dielectric film from  
15 the diaphragm. The electret assembly including the diaphragm and backplate are conveniently mounted on support posts formed in the case. The diaphragm extends across the interior of the case and separates the case into essentially two chambers.

20 The electret dielectric film is connected to suitable electronic circuitry to thereby permit electroacoustical interaction of the diaphragm and electret to provide an electrical signal representative of the acoustic signal. As is known,  
25 the converse operation may be provided by the transducer in that an electrical signal may be applied to the electret to cause the diaphragm to vibrate and thereby develop an acoustic signal which can be coupled out of the acoustic chamber.

30

#### Summary of the Invention

The present invention is an improvement over the electret assembly disclosed in above-cited U.S. Patent No. 4,063,050. In the present invention,  
35 the backplate and the included dielectric film surface are mounted in the opening of a support ring

which in turn is mounted to the walls of the case. The backplate and dielectric film which form a charged fixed electrode are positioned within the support ring to provide a spacing between the edges of the backplate and the diaphragm. The spacing lowers undesired capacitance between the backplate electrode and the metalized diaphragm, which forms a movable electrode. The spacing also provides a means or way for the air between the diaphragm surface and the dielectrical material surface to escape into the other chamber of the case.

#### Brief Description of the Drawings

The foregoing and other features, objects and advantages of the present invention will be apparent from the following more particular description of the preferred embodiment of the invention as illustrated in the accompanying drawings wherein:

Figure 1 is an isometric view, partially in cross section, of an electret transducer in accordance with the invention;

Figure 2 is a plan view of case of Figure 1 with portions thereof removed to show the mounting of the diaphragm support ring to the case, and of the backplate to the support ring;

Figure 3 is an isometric view further illustrating the mounting of the backplate to the support ring; and

Figure 4 shows an alternative embodiment of the support ring and the backplate.

#### Description of the Invention

Referring to Figure 1, 2 and 3, the electret transducer 11 of the invention comprises a cup-like case, casing or housing 12 which, in the

embodiment shown, has rectangular shaped walls 15. A mating cover or top 17 which comprises a generally flat plate fits atop the walls 15 and is cemented thereon to close the case 12. An acoustical signal input tube 19 mounted to case 12 communicates to the interior of case 12 through an acoustical opening, indicated generally as numeral 40 in end wall 15, and more particularly with acoustic chamber 20 formed in case 12. An electret transducer assembly 21 is mounted in case 12. The transducer assembly is generally of the type described in U.S. Patent No. 4,063,050, cited above.

Electret assembly 21 includes a diaphragm 22 having a plate or flat portion 23 which extends across the relatively flat bottom or lower surface of case 12 and defines a lower acoustic chamber 20.

Diaphragm 22 may be of polyethylene terephthalate, commonly available under the trademark MYLAR, or of any similar material. The plate portion 23 of diaphragm 22 may be coated with a metallizing layer of conductive material 24, which may be evaporated on its surface. Diaphragm 22 comprises the movable electrode of the electret assembly 21.

A backplate 28, which has an dielectric film coating 29 thereon, is mounted in a support ring 25. Note that the relative thickness of film coating 29 is exaggerated in the drawings. The backplate 28 is rectangular in configuration with rounded corners and is mounted in the rectangular opening 32 of a support ring 25 (see Figures 2 and 3). The dimensions of the backplate are slightly smaller than the opening 32 of the support ring 25 for purposes to be explained. Backplate 28 comprises the fixed electrode of the electret assembly 21.

The support ring 25 is also rectangular in configuration, and its outer edges conform to the

interior dimensions of the walls 15 of case 12. The support ring 25 is secured to the interior surface of the walls 15 such as by a bead of adhesive 43. The support ring 25, backplate 28 and diaphragm 22 define an upper acoustic chamber 20A in case 12.

The interior of the rectangular support ring 25 includes inwardly extending shoulders 30 with a curved inside rim to receive or conform to the rounded corners of the backplate 28. The backplate 28 thus is positioned within the opening of the support ring 25 and secured thereto by a nodule of cement 35 placed at the corner shoulders 30.

Projections or bumps 37 are provided on the lower surface of the backplate 28, as in the above cited patent, which define the relative spacing of the backplate to the diaphragm 22. The projections 37 cooperate with protrusions 16 in the facing portion of the case 12 to provide a reference for locating the assembly within the case 12. As described in the cited patent 4,063,050, the supporting posts 16 are formed as patterned indentations or discrete posts mounted in a pattern at the bottom or interior lower surface 33 of case 12. Posts 16 in the selected pattern configuration, align with corresponding protrusions 37 on the backplate 28 and are utilized to support and position the electret assembly 21 within the case 12. The posts 16 also accurately define the dimensions of the acoustic chamber 20 which is formed between the diaphragm 22 and the bottom of case 12.

In assembly, the diaphragm 22 is positioned adjacent to the backplate 28. As explained above, the spacing between the diaphragm plate portion 23 and the planar portions of backplate 28 is controlled by the protrusions 37 on backplate 28. The electret assembly or subassembly 21 comprising the backplate

28 and diaphragm 22 can then be inserted into the case 12 to rest on the posts 16 on the bottom of the case to thus form the acoustic chamber 20, as noted above.

5           A non-conductive ceramic plate 41 for containing or supporting the electronic circuitry is mounted within case 12 by suitable bracing and or cementing. One edge of plate 41 is mounted in the case 12 by means of the relatively rigid electrical  
10 terminals 47, 48 and 49 each of which have a portion affixed to plate 41 and an opposite portion which extends as by cementing to terminal pads 54 on the insulating board 52 mounted to wall 15 of case 12. The ends of the electrical terminals 47, 49 and 51  
15 which are affixed to plate 41, also connect to the associated electronic circuitry, as disclosed in patent No. 4,063,050 which circuitry is mounted on plate 41. Numeral 51 indicates a grounding tab formed on diaphragm 22 for electrically connecting  
20 with terminal 49; and, reference numeral 52 indicates a weld point from terminal 49 to the case 12. Numeral 45 indicates a connection of backplate 28 to plate 41.

          Importantly, and as mentioned above, in the  
25 present invention the spacing 32 is formed between the backplate 28 and support ring 25. The backplate 28 is smaller than the opening 33 of support ring 25. Thus other than at the corners, or at other selected supports, where the backplate 28 is affixed to the  
30 support ring 25, such as by cementing; the spacing 32 is formed around the backplate and the support ring. In previous constructions, and in contrast to the present invention, the material of the diaphragm 22, which forms the movable electrode, closely surrounds  
35 the sides of the backplate. This close spacing forms a capacitor that is in shunt with the movable portion



23 of the diaphragm 22, which is responsible for the function of the device. This parasitic capacitor shares the charge with active portion 23 of the diaphragm 22 thus reducing the signal voltage available as an output to the associated amplifier. In the present invention, the spacing 32 is provided between the edge of the backplate 28, fixed electrode and the diaphragm 22, movable electrode, to lower the undesired parasitic capacitance. Spacing 32 also provides a means for the air trapped between the diaphragm surface and backplate electret surface to escape into the larger acoustical chamber 20A of the transducer case 12.

A second embodiment of the invention is shown in Figure 4 wherein the inside corners 36A of the support ring 25A form a 90° angle. In this embodiment, the backplate 28A is again smaller than the opening in support ring 25A and includes wings or extensions 37 on the corners thereof which conform to and abut the corners 36A of the support ring 25A. The backplate 28A is secured to the support ring 25A by a nodules of cement 35A placed at each of the corners of the support ring and the backplate to form the spacing 32.

While the invention has been particularly shown and described with reference to preferred embodiments thereof, it will be understood by those skilled in the art that various changes in form and details may be made therein without departing from the spirit and scope of the invention.

CLAIMS

1. An acoustical transducer, comprising in combination, a case having a top, bottom and side walls; and electret assembly including a diaphragm having peripheral portions and a central vibratable plate portion forming a movable electrode, a  
5 diaphragm support ring having an opening thereon mounted in said case, the peripheral portions of said diaphragm being mountable to said support ring, a backplate mounted within the opening of said support  
10 ring to form a spacing between the backplate and the support ring, said backplate having a surface comprising a fixed electrode and cooperating with the diaphragm movable electrode to develop a signal, an acoustical chamber formed between the electret  
15 assembly and the bottom of said case, a second chamber formed between said assembly and the top of said case, said spacing between the backplate and the support ring lowering the capacitance between said electrodes, and said spacing enabling air movement  
20 between said chambers.

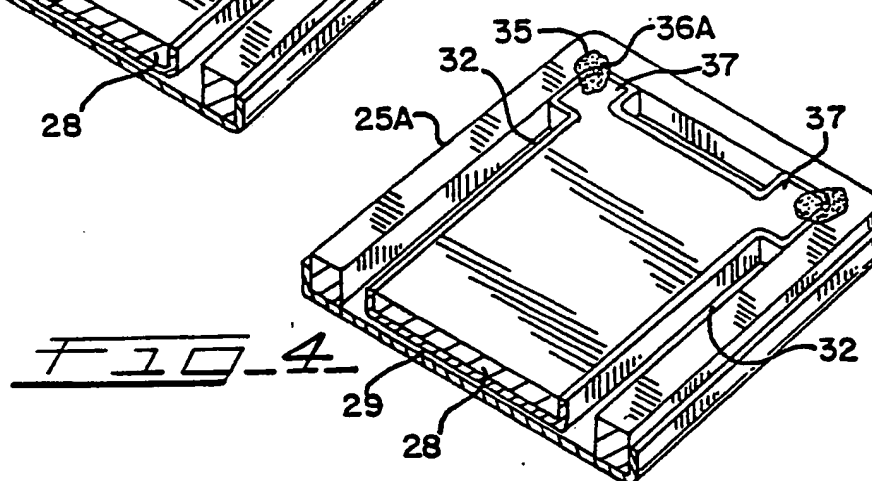
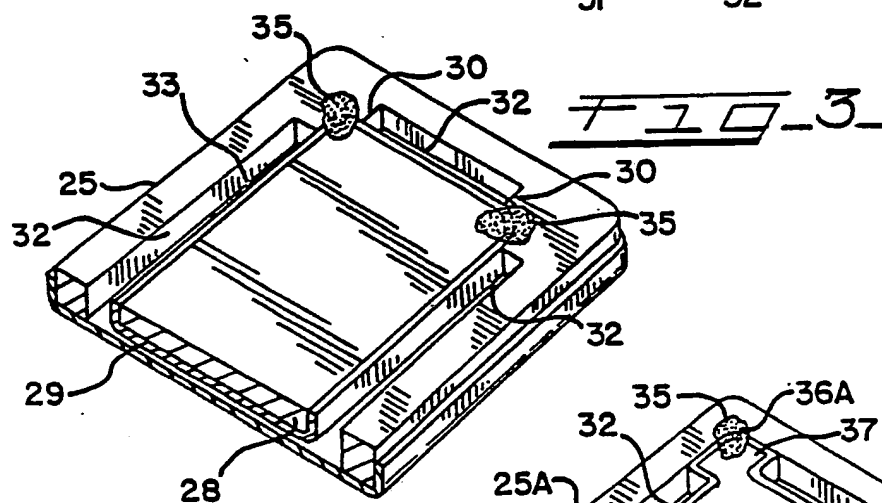
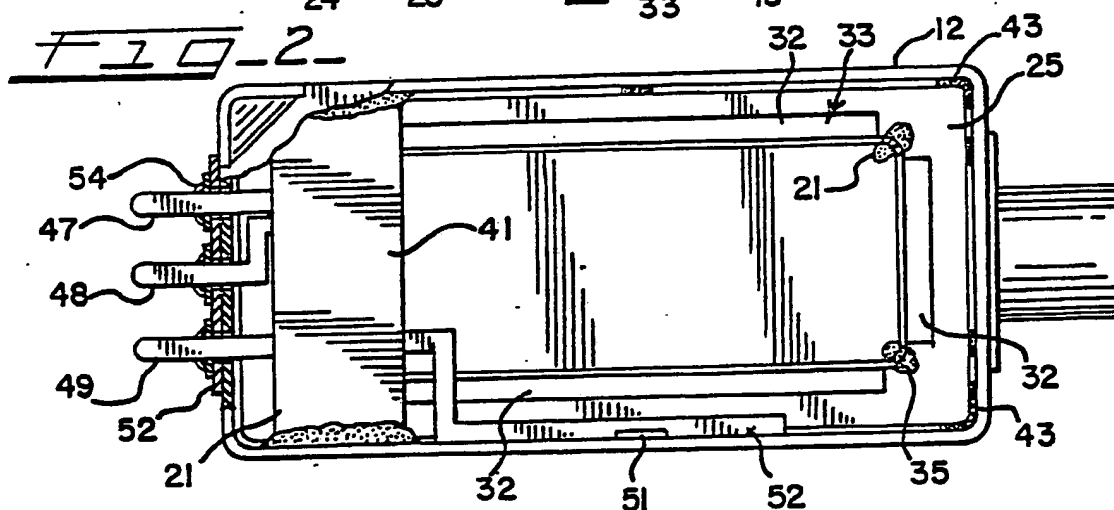
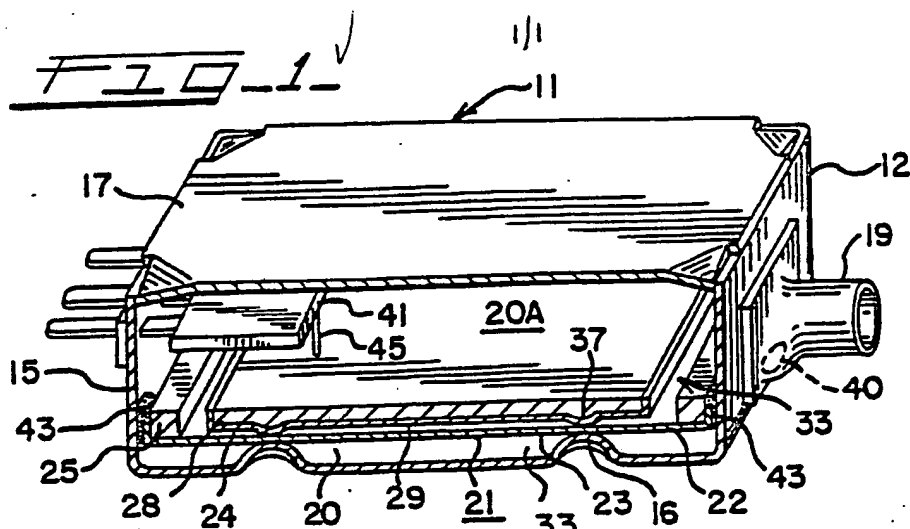
2. An acoustical transducer, comprising in combination, a case having a top, bottom and side walls; an electret assembly including a diaphragm having peripheral portions and a central vibratable plate-like portion having a conductive material thereon, a diaphragm support ring having an opening thereon mounted in said case, the peripheral portions of said diaphragm being mountable to said support ring, a backplate mounted within the opening of said support ring to form at least one spacing between the backplate and the support ring, an electret material, said backplate having a surface on which said electret material is positioned, said electret material cooperating with the diaphragm to develop a signal, support posts on the interior surface of the bottom of the case, protrusions on the surface of the backplate and aligned with said support posts for supporting the electret assembly in the case in spaced relation to the bottom of the case, an acoustical chamber formed between the electret assembly and the interior surface of the bottom of said case, a second chamber formed between said assembly and the top of said case, the spacing between the backplate and electret material and the support ring lowering the capacitance therebetween and hence the undesired capacitance affecting the electret assembly, and the spacing also providing a channel for air between the diaphragm and the electret material to escape into the second chamber of said casing.

3. An acoustical transducer as in claim 2 wherein said spacing extends substantially around said backplate.

4. An acoustical transducer as in claim 2  
wherein said diaphragm includes a flange on its  
periphery, said flange conforming to the wall surface  
of the support ring, and means for adhering said  
5 flange to said ring.

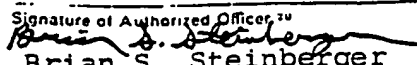
5. An acoustical transducer as in claim 2  
wherein the support ring includes shoulders or  
projections extending into said opening, and said  
backplate is affixed to said shoulders to provide  
5 said at least one spacing between the backplate and  
said ring.

6. An acoustical transducer as in claim 2  
wherein said backplate includes wings or projections  
extending outwardly from the edges of said backplate  
for affixing said backplate to said support ring to  
5 form said at least one spacing.



# INTERNATIONAL SEARCH REPORT

International Application No. **PCT/US87/02259**

<b>I. CLASSIFICATION OF SUBJECT MATTER</b> (if several classification symbols apply, indicate all) <sup>1</sup>		
According to International Patent Classification (IPC) or to both National Classification and IPC <b>INTCL<sup>4</sup> HO4R 19/00 HO2N 1/00</b> <b>U.S. CL 310/309; 367/181; 381/153, 162, 188, 191; 361/271, 278, 283</b>		
<b>II. FIELDS SEARCHED</b>		
Minimum Documentation Searched <sup>4</sup>		
Classification System <sup>1</sup>	Classification Symbols	
U.S.	310/309 367/181 381/153, 162, 188, 191 361/271, 278, 283	
Documentation Searched other than Minimum Documentation to the Extent that such Documents are Included in the Fields Searched <sup>4</sup>		
<b>III. DOCUMENTS CONSIDERED TO BE RELEVANT <sup>1,2</sup></b>		
Category <sup>3</sup>	Citation of Document, <sup>1,6</sup> with indication, where appropriate, of the relevant passages <sup>1,7</sup>	Relevant to Claim No. <sup>1,8</sup>
A	US, A, 4,063,050 (Carlson et al) 13 December 1977 (See entire document)	1-6
A	US, A, 4,117,275 (Miyanaga et al) 26 September 1978 (See entire document)	
A	US, A, 4,246,449 (Biber) 20 January 1981 (See entire document)	
A	US, A, 4,331,840 (Murphy et al) 25 May 1982 (See entire document)	
A	US, A, 4,418,246 (Sawyor) 29 November 1983	1-6
<div style="display: flex; justify-content: space-between;"> <div style="width: 45%;"> <p><sup>*</sup> Special categories of cited documents: <sup>1,9</sup></p> <p>"A" document defining the general state of the art which is not considered to be of particular relevance</p> <p>"E" earlier document but published on or after the international filing date</p> <p>"L" document which may throw doubts on priority claim(s) or which is cited to establish the publication date of another citation or for special reason (as specified)</p> <p>"O" document referring to an oral disclosure, use, exhibition or other means</p> <p>"P" document published prior to the international filing date but later than the priority date claimed</p> </div> <div style="width: 45%;"> <p>"T" later document published after the international filing date or priority date and not in conflict with the application but cited to understand the principle or theory underlying the invention</p> <p>"X" document of particular relevance: the claimed invention cannot be considered novel or cannot be considered to involve an inventive step</p> <p>"Y" document of particular relevance: the claimed invention cannot be considered to involve an inventive step when the document is combined with one or more other such documents, such combination being obvious to a person skilled in the art.</p> <p>"&amp;" document member of the same patent family</p> </div> </div>		
<b>IV. CERTIFICATION</b>		
Date of the Actual Completion of the International Search <sup>2</sup>		Date of Mailing of this International Search Report <sup>2</sup>
20 November 1987		05 JAN 1988
International Searching Authority <sup>1</sup>		Signature of Authorized Officer, <sup>2,4</sup>
ISA/US		 Brian S. Steinberger